



Magnetic Shielding for Electromagnetic Compatibility Applications

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Message from the Guest Editors

There are many research fronts, including:

- Optimization of shield designs (including weight reduction).
- Novel materials and material characterization (including metamaterial research).
- Active magnetic shielding.
- Application assessments and performance verification.
- Measurement techniques.
- Lifecycle assessment.

The objective of this Special Issue is to collate leading research on the subject to act as a reference for emerging applications and further contemporary research. Hence, we are seeking papers related (but not limited) to these research fronts and applications. Original research articles and reviews are welcome.

We look forward to receiving your contributions.

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